TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# **TC74LCX16240FT**

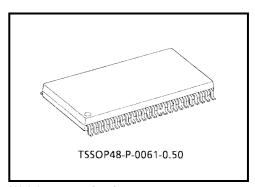
Low-Voltage 16-Bit Bus Buffer (inverted) with 5-V Tolerant Inputs and Outputs

The TC74LCX16240FT is a high-performance CMOS 16-bit bus buffer. Designed for use in 2.5-V or 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

The device is designed for low-voltage (2.5-V or 3.3-V) VCC applications, but it could be used to interface to 5-V supply environment for both inputs and outputs.

This device is inverting 3-state buffer having four active-low output enables. It can be used as four 4-bit buffers two 8-bit buffers or one 16-bit buffer. When the  $\overline{\rm OE}$  input is high, the outputs are in a high-impedance state. This device is designed to be used with 3-state memory address drivers, etc.

All inputs are equipped with protection circuits against static discharge.



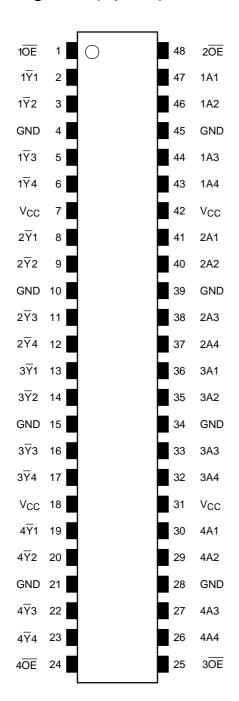
Weight: 0.25 g (typ.)

#### **Features**

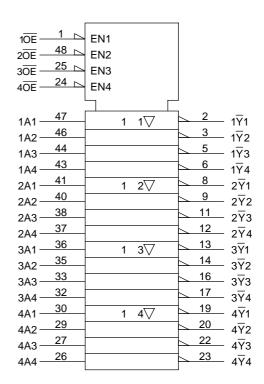
- Low-voltage operation:  $V_{CC} = 2.0$  to 3.6 V
- High-speed operation:  $t_{pd} = 4.5 \text{ ns (max) (VCC} = 3.0 \text{ to } 3.6 \text{ V)}$
- Output current:  $|I_{OH}|/I_{OL} = 24 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$
- Latch-up performance: ±500 mA
- Package: TSSOP (thin shrink small outline package)
- Power-down protection provided on all inputs and outputs

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## Pin Assignment (top view)



## **IEC Logic Symbol**



## **Truth Table**

Inp	Outputs	
1 <del>OE</del>	1A1-1A4	1 <u>Y</u> 1 - 1 <u>Y</u> 4
L	L	Н
L	Н	L
Н	X	Z

Inp	Outputs	
2 <del>OE</del>	2A1-2A4	2 <u>Y</u> 1 - 2 <u>Y</u> 4
L	L	Н
L	Н	L
Н	Х	Z

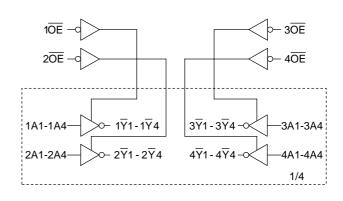
Inp	Outputs	
3 <del>OE</del>	3A1-3A4	3 <u>Y</u> 1 - 3 <u>Y</u> 4
L	L	Н
L	Н	L
Н	Х	Z

Inp	Outputs	
4 <del>OE</del>	4A1-4A4	4 <u>Y</u> 1 - 4 <u>Y</u> 4
L	L	Н
L	Н	L
Н	Х	Z

X: Don't care

Z: High impedance

# **System Diagram**





## **Maximum Ratings**

Characteristics	Symbol	Rating	Unit
Power supply voltage	V <sub>CC</sub>	-0.5 to 6.0	V
Input voltage	V <sub>IN</sub>	-0.5 to 7.0	V
Output voltage	V	-0.5 to 7.0 (Note 1)	V
Output Voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5 (Note 2)	V
Input diode current	I <sub>IK</sub>	-50	mA
Output diode current	lok	±50 (Note 3)	mA
DC output current	I <sub>OUT</sub>	±50	mA
Power dissipation	$P_{D}$	400	mW
DC V <sub>CC</sub> /ground current per supply pin	I <sub>CC</sub> /I <sub>GND</sub>	±100	mA
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Output in OFF state

Note 2: High or low state.  $I_{\mbox{OUT}}$  absolute maximum rating must be observed.

Note 3:  $V_{OUT} < GND, V_{OUT} > V_{CC}$ 

## **Recommended Operating Conditions**

Characteristics	Symbol	Rating	Unit	
Power supply voltage	V	2.0 to 3.6	V	
Fower supply voltage	V <sub>CC</sub>	1.5 to 3.6 (Note 4)	V	
Input voltage	V <sub>IN</sub>	0 to 5.5	V	
Output voltage	Vour	0 to 5.5 (Note 5)	V	
Output voltage	Vout	0 to V <sub>CC</sub> (Note 6)		
		±24 (Note 7)		
Output current	I <sub>OH</sub> /I <sub>OL</sub>	±12 (Note 8)	mA	
		±8 (Note 9)		
Operating temperature	T <sub>opr</sub>	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 10)	ns/V	

Note 4: Data retention only

Note 5: Output in OFF state

Note 6: High or low state

Note 7:  $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$ 

Note 8:  $V_{CC} = 2.7 \text{ to } 3.0 \text{ V}$ 

Note 9:  $V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$ 

Note 10:  $V_{IN} = 0.8$  to 2.0 V,  $V_{CC} = 3.0$  V



## **Electrical Characteristics**

# DC Characteristics ( $Ta = -40 \text{ to } 85^{\circ}\text{C}$ )

Characteristi	ice	Symbol	ymbol Test Condition			Min	Max	Unit	
Onaracteristi		Cyrribor			V <sub>CC</sub> (V)	IVIIII	IVIAX	Offic	
	H-level	\/			2.3 to 2.7	1.7	_		
Input voltage	i i-levei	$V_{IH}$			2.7 to 3.6	2.0	_	V	
input voltage	L-level	V <sub>IL</sub>			2.3 to 2.7	_	0.7	V	
	L-level	۷IL			2.7 to 3.6	_	0.8		
				I <sub>OH</sub> = -100 μA	2.3 to 3.6	V <sub>CC</sub> -0.2			
				$I_{OH} = -8 \text{ mA}$	2.3	1.8	_		
	H-level	V <sub>OH</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$	$I_{OH} = -12 \text{ mA}$	2.7	2.2	_		
				I <sub>OH</sub> = -18 mA	$I_{OH} = -18 \text{ mA}$	3.0	2.4	_	
Output voltage				$I_{OH} = -24 \text{ mA}$	3.0	2.2	_	V	
	L-level \			$I_{OL} = 100 \mu A$	2.3 to 3.6	_	0.2		
		$V_{OL}$ $V_{IN} = V$			I <sub>OL</sub> = 8 mA	2.3	_	0.6	
			$V_{IN} = V_{IH}$ or $V_{IL}$	I <sub>OL</sub> = 12 mA	2.7	_	0.4		
				I <sub>OL</sub> = 16 mA	3.0	_	0.4		
				I <sub>OL</sub> = 24 mA	3.0	_	0.55		
Input leakage current		I <sub>IN</sub>	$V_{IN} = 0$ to 5.5 V		2.3 to 3.6	_	±5.0	μΑ	
3-state output OFF sta	te current	lo-	$V_{IN} = V_{IH}$ or $V_{IL}$		2.3 to 3.6	_	±5.0	μА	
3-state output OFF sta	te current	l <sub>OZ</sub>	V <sub>OUT</sub> = 0 to 5.5 V		2.3 10 3.0		±3.0	μΑ	
Power-off leakage curr	ent	l <sub>OFF</sub>	$V_{IN}/V_{OUT} = 5.5 V$		0	_	10.0	μΑ	
Quiescent supply curre	ant	loo	V <sub>IN</sub> = V <sub>CC</sub> or GND		2.3 to 3.6	_	20.0		
Quiescent supply cure	71 IL	Icc	$V_{IN}/V_{OUT} = 3.6 \text{ to } 5.5 \text{ V}$		2.3 to 3.6	_	±20.0	μΑ	
Increase in Icc per inpu	ut	Δlcc	$V_{IH} = V_{CC} - 0.6 V$		2.3 to 3.6	_	500		

## AC Characteristics ( $Ta = -40 \text{ to } 85^{\circ}\text{C}$ )

Characteristics	Symbol	Test Condition			Min	Max	Unit				
Characteristics	Symbol	rest Condition	V <sub>CC</sub> (V)	CL(pF)	IVIIII	IVIAX	Offic				
	<b>+</b>		$2.5\pm0.2$	30	1.5	5.4					
Propagation delay time	t <sub>pLH</sub>	Figure 1, Figure 2	2.7	50	1.5	5.3	ns				
	<sup>t</sup> pHL		$3.3 \pm 0.3$	50	1.5	4.5					
	4	t <sub>pZL</sub> Figure 1, Figure 3	$2.5\pm0.2$	30	1.5	7.0					
3-state output enable time			2.7	50	1.5	6.0	ns				
			$3.3\pm0.3$	50	1.5	5.4					
	t <sub>pLZ</sub>		$2.5\pm0.2$	30	1.5	6.4					
3-state output disable time							Figure 1, Figure 3	2.7	50	1.5	5.4
\(\frac{1}{2}\)	t <sub>pHZ</sub>		$3.3 \pm 0.3$	50	1.5	5.3					
			$2.5\pm0.2$	30							
Output to output skew	tosLH	(Note 11)	2.7	50			ns				
	tosHL		$3.3\pm0.3$	50	_	1.0					

Note 11: Parameter guaranteed by design.  $(t_{OSLH} = |t_{DLHm} - t_{DLHn}|, \, t_{OSHL} = |t_{DHLm} - t_{DHLn}|)$ 

# Dynamic Switching Characteristics (Ta = 25°C, input: $t_r = t_f = 2.5$ ns, $R_L = 500 \Omega$ )

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Quiet output maximum	V <sub>OLP</sub>	V <sub>IH</sub> = 2.5 V, V <sub>IL</sub> = 0 V, C <sub>L</sub> =30pF	2.5	0.6	V
dynamic V <sub>OL</sub>	VOLP	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}, C_L = 50 \text{pF}$	3.3	0.8	,
Quiet output minimum	V <sub>OLV</sub>	$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}, C_L = 30 \text{pF}$	2.5	0.6	V
dynamic V <sub>OL</sub>	I V OLVI	V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V, C <sub>L</sub> =50pF	3.3	0.8	٧

# **Capacitive Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance	C <sub>IN</sub>	_		3.3	7	pF
Output capacitance	C <sub>OUT</sub>	_		3.3	8	pF
Power dissipation capacitance	C <sub>PD</sub>	f <sub>IN</sub> = 10 MHz	(Note 12)	3.3	25	pF

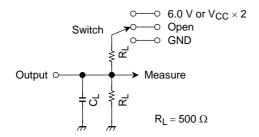
Note 12: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

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Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/16 \text{ (per bit)}$ 

#### **AC Test Circuit**



Parameter	Switch			
t <sub>pLH</sub> , t <sub>pHL</sub>	Open			
t <sub>pLZ</sub> , t <sub>pZL</sub>	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$			
t <sub>pHZ</sub> , t <sub>pZH</sub>	GND			

Figure 1

## **AC Waveform**

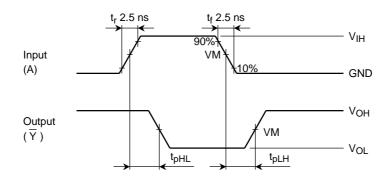


Figure 2 t<sub>pLH</sub>, t<sub>pHL</sub>

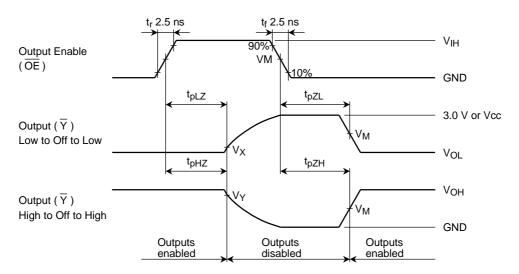
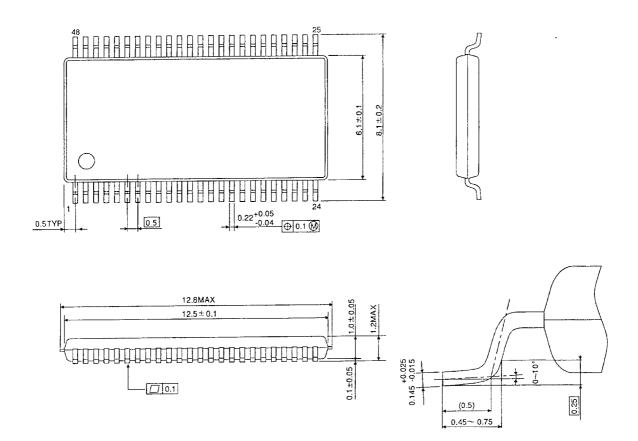


Figure 3  $t_{pLZ}$ ,  $t_{pHZ}$ ,  $t_{pZL}$ ,  $t_{pZH}$ 

Symbol	Vcc					
Symbol	$3.3\pm0.3~\textrm{V}$	2.7 V	$2.5\pm0.2~\textrm{V}$			
V <sub>IH</sub>	2.7 V	2.7 V	Vcc			
$V_{M}$	1.5 V	1.5 V	V <sub>CC</sub> /2			
VX	$V_{OL} + 0.3 V$	V <sub>OL</sub> + 0.3 V	V <sub>OL</sub> + 0.15 V			
VY	V <sub>OH</sub> – 0.3 V	V <sub>OH</sub> – 0.3 V	V <sub>OH</sub> – 0.15 V			

# **Package Dimensions**

TSSOP48-P-0061-0.50 Unit: mm



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Weight: 0.25 g (typ.)

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